cicor



Wangs, Switzerland

Production site for substrates and hybrid circuits

The Cicor site in Wangs specializes in the manufacture of thin-film circuits on rigid and flexible substrates and has extensive manufacturing expertise in this field. Manufacturing takes place in a clean room using microelectronic manufacturing processes such as lithography, sputtering, evaporation, etching, electroplating and passive resistance matching. Other machining operations include laser drilling of holes, laser contouring, and sawing as

a separation step from multiprocess to chip. Production and processes are designed for maximum flexibility to meet special requirements for substrate materials and process combinations. The site manufactures thin film circuits on a wide variety of substrate materials (Al $_{\rm 2}{\rm O}_{\rm 3}$, AlN, LCP, polyimide, ferrites, glass, sapphire, quartz ect.) in prototype and series production.







Competencies and services

Thin-film substrates

- Rigid and flexible substrates, multilayers
- Flexible multilayer circuits with very high resolution (10 μm)
- Metallic coating
- Sputtering
- Electroplating (copper, nickel, gold)
- Photolithography
- Wet etching, dry etching (RIE)
- Eutectic AuSn by evaporation
- Clean rooms ISO class 7 to ISO 6 (class 10'000 bis 100), 850 m²

Automatic laser trimming

- Laser trimming using a YAG laser
- High-value resistors

Forming and singulating

- CO₂ laser cutting
- Diamond cutting

Markets



Industrial



Medical



Aerospace and defence



Wareables

Certifications

- ISO 9001 Quality
- EN 9100 Aerospace
- AEO
- JOSCAR



Reinhardt Microtech AG

Aeulistrasse 10 7323 Wangs, Switzerland Tel. +41 81 720 04 56 info-thinfilm@cicor.com

The Cicor Group is a globally active provider of full-cycle electronic solutions from research and development to manufacturing and supply chain management. Cicor's approximately 2650 employees at 16 locations worldwide are serving leaders from the medical, industrial and aerospace & defence industries. Cicor creates value to its customers through the combination of customer-specific development solutions, high-tech components, as well as electronic device manufacturing.

